



## FEATURES

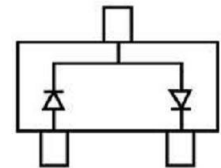
- Peak Forward Current:  $I_{FM}=200\text{mA}$
- Power Dissipation of 200mw



SOT-23

## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
BAS40-04	SOT-23	44	3000



## MAXIMUM RATINGS (Ta=25 unless otherwise noted)

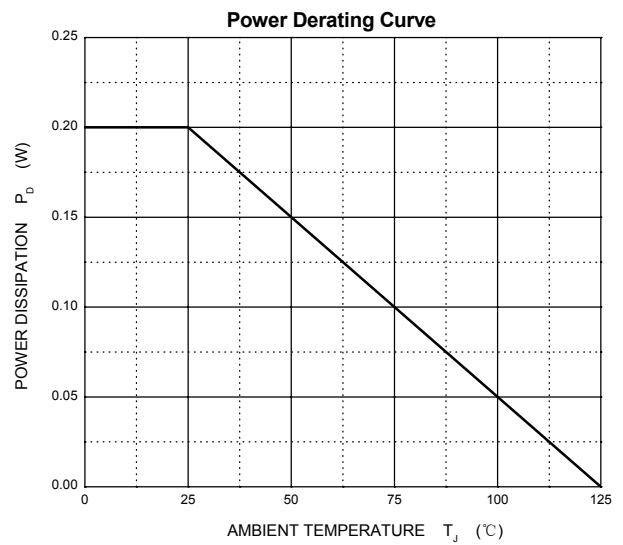
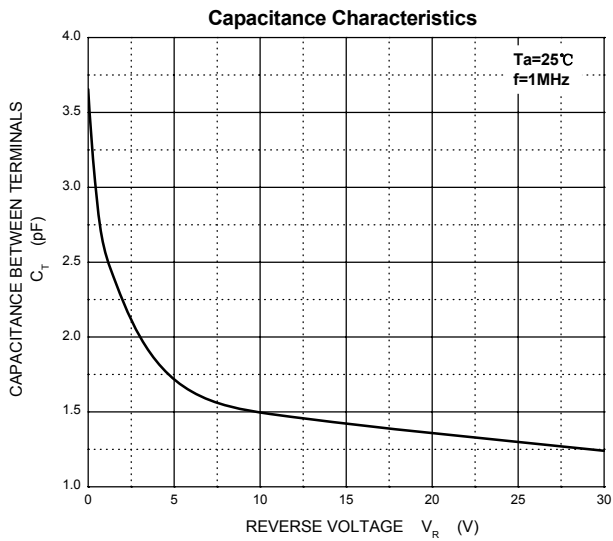
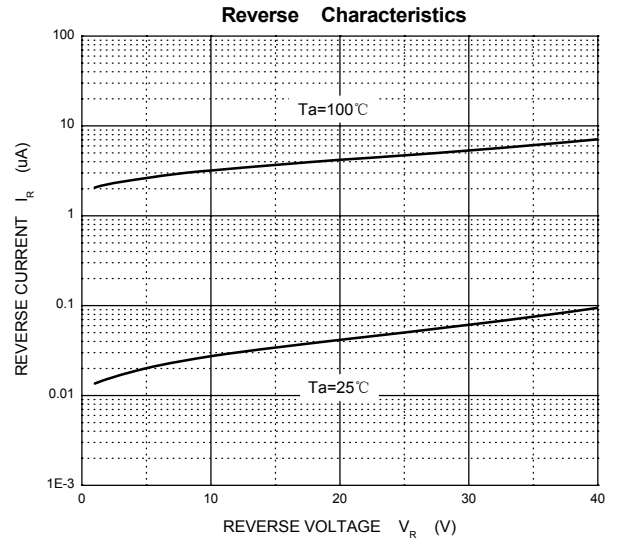
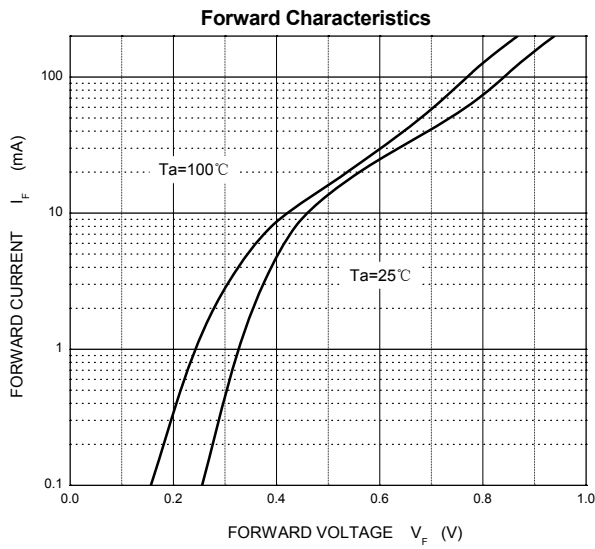
Parameter	Symbol	Limit	Unit
Peak Repetitive Peak Reverse Voltage	$V_{RRM}$	40	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_R$		
Forward Continuous Current	$I_{FM}$	200	mA
Average Rectified Output Current	$I_O$	200	mA
Non-Repetitive Peak Forward Surge Current @ t = 8.3ms	$I_{FSM}$	0.6	A
Power Dissipation	$P_D$	200	mW
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	500	°C/W
Operating Junction Temperature	$T_J$	125	°C
Storage Temperature	$T_{STG}$	-55~+150	°C

## ELECTRICAL CHARACTERISTICS (Ta=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Reverse breakdown voltage	$V_{(BR)}$	$I_R=10\mu\text{A}$	40		V
Reverse voltage leakage current	$I_R$	$V_R=30\text{V}$		200	nA
Forward voltage	$V_F$	$I_F=1\text{mA}$ $I_F=40\text{mA}$		380 1000	mV
Diode capacitance	$C_D$	$V_R=0, f=1\text{MHz}$		5	pF
Reverse recovery time	$t_{rr}$	$I_{rr}=1\text{mA}, I_R=I_F=10\text{mA}$ $R_L=100\Omega$		5	ns

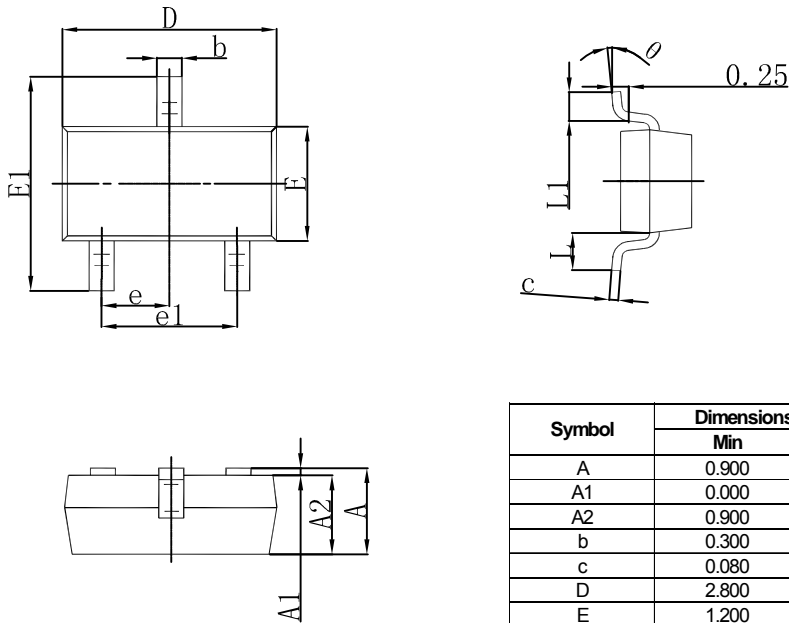


### Typical Characteristics



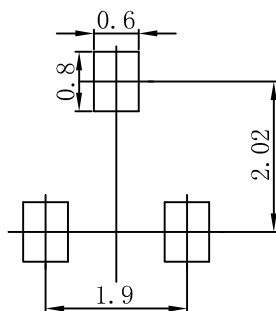


### SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
theta	0°	8°	0°	8°

### SOT-23 Suggested Pad Layout



Note:  
 1. Controlling dimension: in millimeters.  
 2. General tolerance:  $\pm 0.05$  mm.  
 3. The pad layout is for reference purposes only.



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